## Features

- $N$ channel
- Enhancement mode
- Avalanche rated
- Logic Level
- $\mathrm{d} v / \mathrm{d} t$ rated
- $175{ }^{\circ} \mathrm{C}$ operating temperature


## Product Summary

| Drain source voltage | $V_{\mathrm{DS}}$ | 55 | V |
| :--- | :--- | :---: | :--- |
| Drain-Source on-state resistance | $R_{\mathrm{DS}(\mathrm{on})}$ | 0.015 | $\Omega$ |
| Continuous drain current | $I_{\mathrm{D}}$ | 47 | A |



| Type | Package | Ordering Code | Packaging |
| :--- | :--- | :--- | :--- |
| BUZ102SL | P-TO220-3-1 | Q67040-S4010-A2 | Tube |
| BUZ102SL E3045A | P-TO263-3-2 | Q67040-S4010-A6 | Tape and Reel |
| BUZ102SL E3045 | P-TO263-3-2 | Q67040-S4010-A5 | Tube |


| Pin 1 | Pin 2 | Pin 3 |
| :---: | :---: | :---: |
| G | D | S |

Maximum Ratings, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Parameter | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Continuous drain current $\begin{aligned} & T_{\mathrm{C}}=25^{\circ} \mathrm{C} \\ & T_{\mathrm{C}}=100^{\circ} \mathrm{C} \end{aligned}$ | $I_{\text {D }}$ | $\begin{aligned} & 47 \\ & 33 \end{aligned}$ | A |
| Pulsed drain current $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | /Dpulse | 188 |  |
| Avalanche energy, single pulse $I_{\mathrm{D}}=47 \mathrm{~A}, V_{\mathrm{DD}}=25 \mathrm{~V}, R_{\mathrm{GS}}=25 \Omega$ | $E_{\text {AS }}$ | 245 | mJ |
| Avalanche energy, periodic limited by $T_{\text {jmax }}$ | $E_{\text {AR }}$ | 12 |  |
| Reverse diode $\mathrm{d} v / \mathrm{d} t$ $\begin{aligned} & I_{\mathrm{S}}=47 \mathrm{~A}, V_{\mathrm{DS}}=40 \mathrm{~V}, \mathrm{~d} i / \mathrm{d} t=200 \mathrm{~A} / \mu \mathrm{s}, \\ & T_{\text {jmax }}=175^{\circ} \mathrm{C} \end{aligned}$ | $\mathrm{d} v / \mathrm{d} t$ | 6 | kV/ $\mu \mathrm{s}$ |
| Gate source voltage | $V_{G S}$ | -20 | V |
| Power dissipation $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $P_{\text {tot }}$ | 120 | W |
| Operating and storage temperature | $T_{\mathrm{j}}, T_{\text {stg }}$ | $-55 \ldots+175$ | C |
| IEC climatic category; DIN IEC 68-1 |  | 55/175/56 |  |

## Thermal Characteristics

| Parameter | Symbol | Values |  |  | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| Characteristics | $R_{\text {thJC }}$ | - | - | 1.25 | K/W |
| Thermal resistance, junction - case | $R_{\text {thJA }}$ | - | - | 62 |  |
| Thermal resistance, junction - ambient, leded | $R_{\text {thJA }}$ |  |  |  |  |
| SMD version, device on PCB: |  | - | - | 62 |  |
| @ min. footprint |  | - | - | 40 |  |
| @ $6 \mathrm{~cm}^{2}$ cooling area ${ }^{1}$ ) |  |  |  |  |  |

Electrical Characteristics, at $T_{\mathrm{i}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| Static Characteristics |  |  |  |  |  |
| Drain- source breakdown voltage $V_{\mathrm{GS}}=0 \mathrm{~V}, I_{\mathrm{D}}=0.25 \mathrm{~mA}$ | $V_{(\mathrm{BR}) \mathrm{DSS}}$ | 55 | - | - | V |
| Gate threshold voltage, $V_{G S}=V_{D S}$ b = $90 \mu \mathrm{~A}$ | $V_{\mathrm{GS}}(\mathrm{th})$ | 1.2 | 1.6 | 2 |  |
| Zero gate voltage drain current $\begin{aligned} & V_{\mathrm{DS}}=50 \mathrm{~V}, V_{\mathrm{GS}}=0 \mathrm{~V}, T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & V_{\mathrm{DS}}=50 \mathrm{~V}, V_{\mathrm{GS}}=0 \mathrm{~V}, T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ | IDSS | - | 0.1 | $\begin{gathered} 1 \\ 100 \end{gathered}$ | $\mu \mathrm{A}$ |
| Gate-source leakage current $V_{\mathrm{GS}}=20 \mathrm{~V}, V_{\mathrm{DS}}=0 \mathrm{~V}$ | $I_{\text {GSS }}$ | - | 10 | 100 | nA |
| Drain-Source on-state resistance $\begin{aligned} & V_{\mathrm{GS}}=4.5 \mathrm{~V}, I_{\mathrm{D}}=33 \mathrm{~A} \\ & V_{\mathrm{GS}}=10 \mathrm{~V}, I_{\mathrm{D}}=33 \mathrm{~A} \end{aligned}$ | $R_{\text {DS(on) }}$ | - | 0.021 0.0135 | 0.024 0.015 | $\Omega$ |

1 Device on $40 \mathrm{~mm} * 40 \mathrm{~mm} * 1.5 \mathrm{~mm}$ epoxy PCB FR4 with 6 cm 2 (one layer, $70 \mu \mathrm{~m}$ thick) copper area for drain connection. PCB is vertical without blown air.

Electrical Characteristics, at $T_{i}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| Dynamic Characteristics |  |  |  |  |  |
| Transconductance $V_{\mathrm{DS}} \geq 2^{*} I_{\mathrm{D}}{ }^{\star} R_{\mathrm{DS}}$ (on)max,$I_{\mathrm{D}}=33 \mathrm{~A}$ | $g_{\text {fs }}$ | 10 | 40 | - | S |
| Input capacitance $V_{\mathrm{GS}}=0 \mathrm{~V}, V_{\mathrm{DS}}=25 \mathrm{~V}, f=1 \mathrm{MHz}$ | $C_{\text {iss }}$ | - | 1380 | 1730 | pF |
| Output capacitance $V_{\mathrm{GS}}=0 \mathrm{~V}, V_{\mathrm{DS}}=25 \mathrm{~V}, f=1 \mathrm{MHz}$ | $C_{\text {oss }}$ | - | 410 | 515 |  |
| Reverse transfer capacitance $V_{G S}=0 \mathrm{~V}, V_{\mathrm{DS}}=25 \mathrm{~V}, f=1 \mathrm{MHz}$ | $C_{\text {rss }}$ | - | 230 | 290 |  |
| Turn-on delay time $\begin{aligned} & V_{\mathrm{DD}}=30 \mathrm{~V}, V_{\mathrm{GS}}=4.5 \mathrm{~V}, I_{\mathrm{D}}=47 \mathrm{~A}, \\ & R_{\mathrm{G}}=3.6 \Omega \end{aligned}$ | $t_{\mathrm{d}(\mathrm{on})}$ | - | 15 | 25 | ns |
| Rise time $\begin{aligned} & V_{\mathrm{DD}}=30 \mathrm{~V}, V_{\mathrm{GS}}=4.5 \mathrm{~V}, I_{\mathrm{D}}=47 \mathrm{~A}, \\ & R_{\mathrm{G}}=3.6 \Omega \end{aligned}$ | $t_{r}$ | - | 30 | 45 |  |
| Turn-off delay time $\begin{aligned} & V_{\mathrm{DD}}=30 \mathrm{~V}, V_{\mathrm{GS}}=4.5 \mathrm{~V}, I_{\mathrm{D}}=47 \mathrm{~A}, \\ & R_{\mathrm{G}}=3.6 \Omega \end{aligned}$ | $t_{\mathrm{d}(\text { (off) }}$ | - | 30 | 45 |  |
| Fall time $\begin{aligned} & V_{\mathrm{DD}}=30 \mathrm{~V}, V_{\mathrm{GS}}=4.5 \mathrm{~V}, I_{\mathrm{D}}=47 \mathrm{~A}, \\ & R_{\mathrm{G}}=3.6 \Omega \end{aligned}$ | $t_{f}$ | - | 20 | 30 |  |

Electrical Characteristics, at $T_{\mathrm{i}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| Dynamic Characteristics | $Q_{\mathrm{gs}}$ | - | 7 | 10.5 | nC |
| Gate to source charge <br> $V_{\mathrm{DD}}=40 \mathrm{~V}, I_{\mathrm{D}}=47 \mathrm{~A}$ | $Q_{\mathrm{gd}}$ | - | 23 | 34.5 |  |
| Gate to drain charge <br> $V_{\mathrm{DD}}=40 \mathrm{~V}, I_{\mathrm{D}}=47 \mathrm{~A}$ | $Q_{g}$ | - | 60 | 90 |  |
| Gate charge total <br> $V_{\mathrm{DD}}=40 \mathrm{~V}, I_{\mathrm{D}}=47 \mathrm{~A}, V_{\mathrm{GS}}=0$ to 10 V |  |  |  |  |  |
| Gate plateau voltage <br> $V_{\mathrm{DD}}=40 \mathrm{~V}, I_{\mathrm{D}}=47 \mathrm{~A}$ | $V_{\text {(plateau) }}$ | - | 4.1 | - | V |

Reverse Diode

| Inverse diode continuous forward current $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $I_{S}$ | - | - | 47 | A |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Inverse diode direct current,pulsed $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $I_{\text {SM }}$ | - | - | 188 |  |
| Inverse diode forward voltage $V_{\mathrm{GS}}=0 \mathrm{~V}, I_{\mathrm{F}}=94 \mathrm{~A}$ | $V_{\text {SD }}$ | - | 1.1 | 1.7 | V |
| Reverse recovery time $V_{\mathrm{R}}=30 \mathrm{~V}, I_{\mathrm{F}}=I_{\mathrm{S}}, \mathrm{~d} i_{\mathrm{F}} / \mathrm{d} t=100 \mathrm{~A} / \mu \mathrm{s}$ | $t_{\text {rr }}$ | - | 75 | 115 | ns |
| Reverse recovery charge $V_{\mathrm{R}}=30 \mathrm{~V}, I_{\mathrm{F}}=I_{\mathrm{S}}, \mathrm{~d} i_{\mathrm{F}} / \mathrm{d} t=100 \mathrm{~A} / \mu \mathrm{s}$ | $Q_{\text {rr }}$ | - | 0.15 | 0.25 | $\mu \mathrm{C}$ |

## Power Dissipation

$$
P_{\mathrm{tot}}=f\left(T_{\mathrm{C}}\right)
$$



## Safe operating area

$I_{D}=f\left(V_{D S}\right)$
parameter: $D=0, T_{C}=25^{\circ} \mathrm{C}$


Typ. output characteristics
$I_{D}=f\left(V_{D S}\right)$
parameter: $t_{\mathrm{p}}=80 \mu \mathrm{~s}$


Typ. transfer characteristics $I_{D}=f\left(V_{G S}\right)$
parameter: $t_{\mathrm{p}}=80 \mu \mathrm{~s}$
$V_{D S} \geq 2 \times I_{D} \times R_{D S(o n) m a x}$


## Typ. drain-source-on-resistance

$R_{\mathrm{DS}(\text { on })}=f\left(I_{\mathrm{D}}\right)$
parameter: $V_{G S}$


Typ. forward transconductance
$g_{\mathrm{s}}=f(b) ; T_{\mathrm{j}}=25^{\circ} \mathrm{C}$
parameter: $g_{\text {ts }}$


## Drain-source on-resistance

$R_{\mathrm{DS}(\text { on })}=f\left(T_{\mathrm{j}}\right)$
parameter : $I_{D}=33 \mathrm{~A}, V_{G S}=4.5 \mathrm{~V}$


Typ. capacitances
$C=f\left(V_{D S}\right)$
parameter: $V_{\mathrm{GS}}=0 \mathrm{~V}, f=1 \mathrm{MHz}$


Gate threshold voltage
$V_{\mathrm{GS}}(\mathrm{th})=f\left(T_{\mathrm{j}}\right)$
parameter: $V_{G S}=V_{D S}, L_{D}=90 \mu \mathrm{~A}$


Forward characteristics of reverse diode
$I_{F}=f\left(\mathrm{~V}_{\mathrm{SD}}\right)$
parameter: $T_{j}, \hbar_{p}=80 \mu \mathrm{~s}$


## Avalanche Energy $E_{\text {AS }}=f\left(T_{\mathrm{j}}\right)$

parameter: $I_{D}=47 \mathrm{~A}, V_{D D}=25 \mathrm{~V}$
$R_{G S}=25 \Omega$


Drain-source breakdown voltage
$V_{(\mathrm{BR}) \mathrm{DSS}}=f\left(T_{\mathrm{j}}\right)$


Typ. gate charge
$V_{\mathrm{GS}}=f\left(Q_{\text {Gate }}\right)$
parameter: $I_{\text {puls }}=47 \mathrm{~A}$


